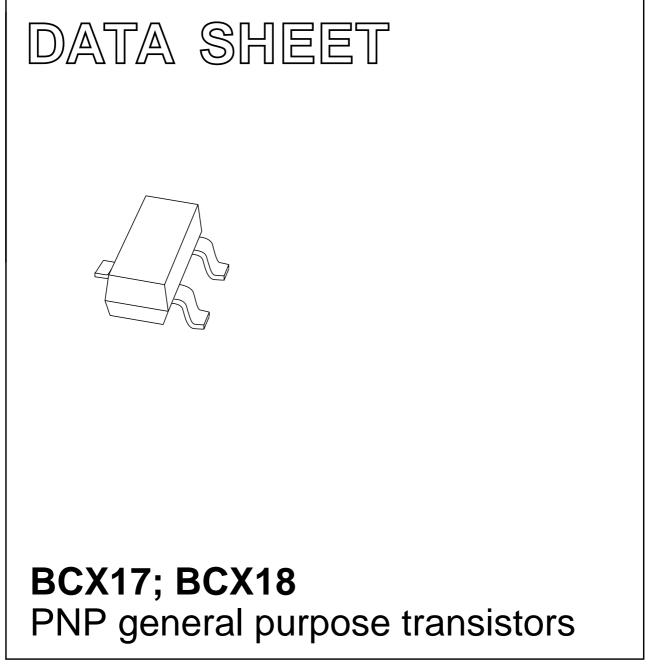
DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 1999 May 31 2004 Jan 16



FEATURES

- High current (max. 500 mA)
- Low voltage (max. 45 V).

APPLICATIONS

- Saturated switching and driver applications e.g. for industrial service
- Thick and thin-film circuits.

DESCRIPTION

PNP transistor in a SOT23 plastic package. NPN complement: BCX19.

MARKING

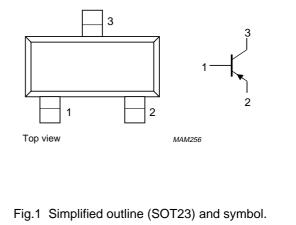
TYPE NUMBER	MARKING CODE ⁽¹⁾
BCX17	T1*
BCX18	T2*

Note

- 1. * = p : Made in Hong Kong.
 - * = t : Made in Malaysia.
 - * = W : Made in China.

ORDERING INFORMATION

1	base			
2	emitter			
3	collector			



ТҮРЕ	PE PACKAGE		
NUMBER	NAME	DESCRIPTION	VERSION
BCX17	_	plastic surface mounted package; 3 leads	SOT23
BCX18			

PINNING

PIN

BCX17; BCX18

DESCRIPTION

BCX17; BCX18

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	PARAMETER CONDITIONS		MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter			
	BCX17		_	-50	V
	BCX18		_	-30	V
V _{CEO}	collector-emitter voltage	open base			
	BCX17		-	-45	V
	BCX18		_	-25	V
V _{EBO}	emitter-base voltage	open collector	-	-5	V
I _C	collector current (DC)		_	-500	mA
I _{CM}	peak collector current		_	-1	A
I _{BM}	peak base current		_	-200	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	-	250	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Note

1. Transistor mounted on an FR4 printed-circuit board.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	note 1	500	K/W

Note

1. Transistor mounted on an FR4 printed-circuit board.

BCX17; BCX18

CHARACTERISTICS

 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

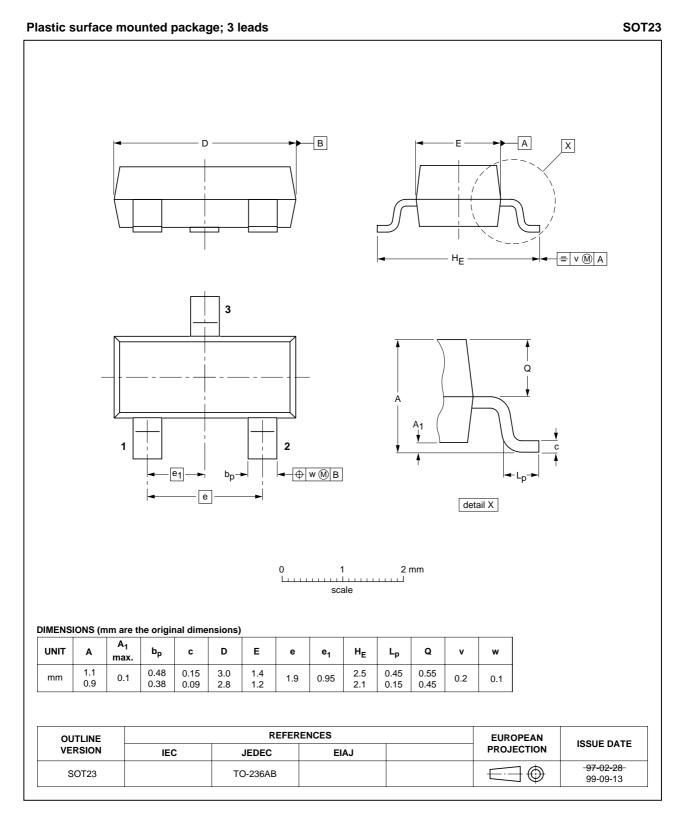
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector cut-off current	$I_E = 0; V_{CB} = -20 V$	_	_	-100	nA
		$I_E = 0; V_{CB} = -20 V; T_j = 150 \ ^{\circ}C$	_	_	-5	μA
I _{EBO}	emitter cut-off current	$I_{C} = 0; V_{EB} = -5 V$	_	_	-100	nA
h _{FE}	DC current gain	$I_{C} = -100 \text{ mA}; V_{CE} = -1 \text{ V}$	100	-	600	
		$I_{C} = -300 \text{ mA}; V_{CE} = -1 \text{ V}$	70	—	-	
		$I_{C} = -500 \text{ mA}; V_{CE} = -1 \text{ V}$	40	-	-	
V _{CEsat}	collector-emitter saturation voltage	$I_{C} = -500 \text{ mA}; I_{B} = -50 \text{ mA}$	-	_	-620	mV
V_{BE}	base-emitter voltage	$I_{C} = -500 \text{ mA}; V_{CE} = -1 \text{ V}; \text{ note } 1$	-	—	-1.2	V
C _c	collector capacitance	$I_E = I_e = 0; V_{CB} = -10 V; f = 1 MHz$	_	9	_	pF
f _T	transition frequency	$I_{C} = -10 \text{ mA}; V_{CE} = -5 \text{ V}; f = 100 \text{ MHz}$	80	-	-	MHz

Note

1. V_{BE} decreases by approximately $-2 \text{ mV/}^{\circ}C$ with increasing temperature.

BCX17; BCX18

PACKAGE OUTLINE



BCX17; BCX18

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
11	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

Notes

- 1. Please consult the most recently issued data sheet before initiating or completing a design.
- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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